



<b>Spec. No.</b>	PS-DD-S56222/S56223B7
<b>Rev.</b>	A

# PRODUCT SPECIFICATION

**Model No:CSD-S56222B7/S56223B7**

Descriptions:
<ul style="list-style-type: none"> <li>■ 0.56 Inch Dual Digit SMD Display</li> <li>■ Emitting Color : Super Bright Blue</li> </ul>



CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY

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**Model No : CSD-S56222/S56223B7**

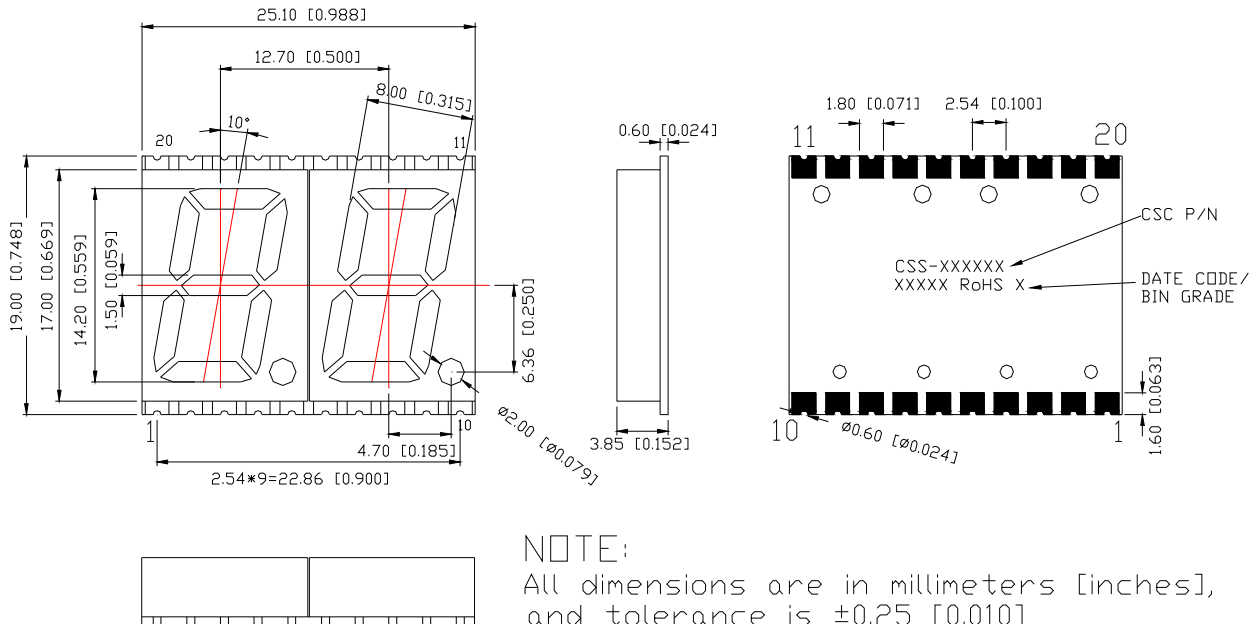
**Features -**

1. 0.56 inch (14.20mm) digit height.
2. Qualified according to JEDEC moisture sensitivity Level 2a.
3. RoHS compliant.
4. Low power consumption.
5. ESD > 1KV(HBM).
6. Easy mounting on P.C. board.

**Device Selection Guide -**

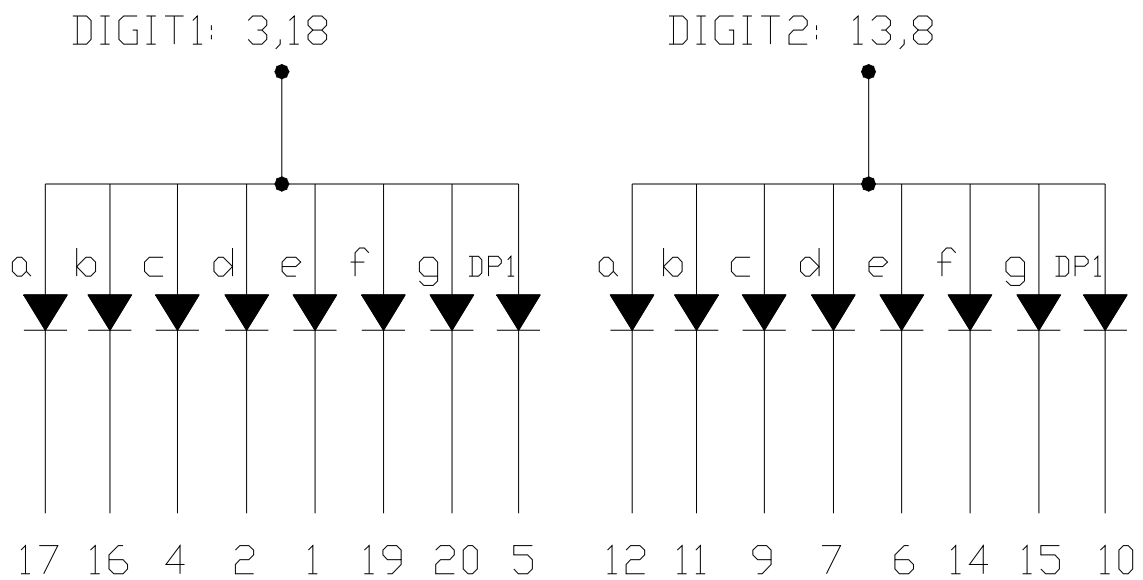
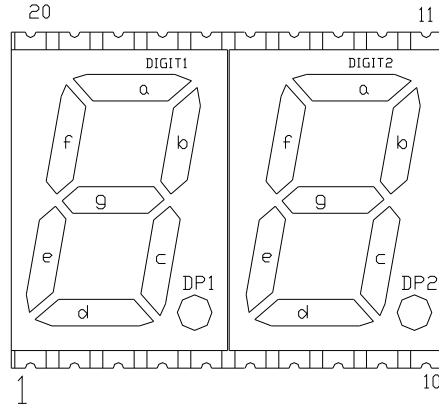
Model No.	Chip		Description
	Material	Emitting Color	
CSD-S56222B7	InGaN	Super Bright Blue	Common Anode
CSD-S56223B7	InGaN	Super Bright Blue	Common Cathode

**Mechanical Dimensions -**



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Internal Circuit Diagrams -



CSD-S56222 Common Anode.  
( CSD-S56223 Common Cathode.)


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**■ Absolute Maximum Rating -**

(Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Dissipation Per Dice	<b>P<sub>AD</sub></b>	120	mW
Continuous Forward Current Per Dice	<b>I<sub>AF</sub></b>	30	mA
Peak Current Per Dice(duty cycle 1/10,1KHz)	<b>I<sub>PF</sub></b>	100	mA
Derating Linear From 25°C Per Dice	-	0.4	mA/°C
Reverse Voltage Per Dice	<b>V<sub>R</sub></b>	5	V
Operating Temp.	<b>T<sub>opr</sub></b>	-40 ~ +105	°C
Storage Temp.	<b>T<sub>stg</sub></b>	-40 ~ +105	°C

**Note:Solder temperature 1/16 inch below seating plane for 3 seconds at 260°C**
**■ Electro-optical Characteristics -**

(Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Voltage Per Segment	<b>V<sub>F</sub></b>	-	3.5	4	V	I <sub>F</sub> =20mA
Luminous Intensity Per Segment	<b>I<sub>v</sub></b>	5	20	-	mcd	I <sub>F</sub> =10mA
Dominant Wavelength	$\lambda_d$	-	470	-	nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	$\Delta \lambda$	-	30	-	nm	I <sub>F</sub> =20mA
Reverse Current	<b>I<sub>R</sub></b>	-	-	50	$\mu$ A	V <sub>R</sub> =5V
Luminous Intensity Matching Ratio	<b>I<sub>V-m</sub></b>	-	-	2:1	-	I <sub>F</sub> =10mA



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**Typical Electrical / Optical Charateristics Curves -**

**(Ta = 25°C Unless Otherwise Noted)**

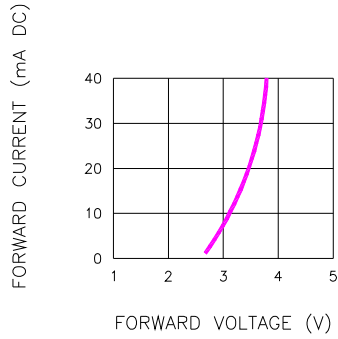


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

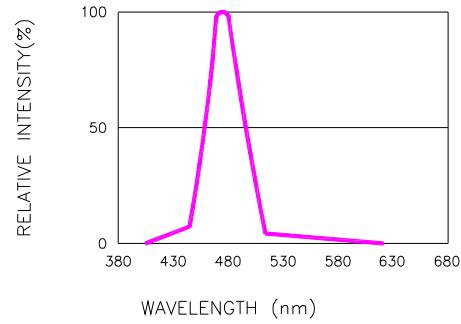


Fig.2 RELATIVE INTENSITY VS. WAVELENGTH

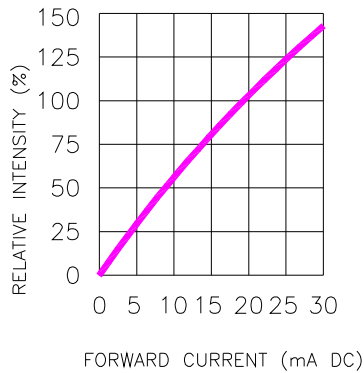


Fig.3 RELATIVE INTENSITY VS. FORWARD CURRENT

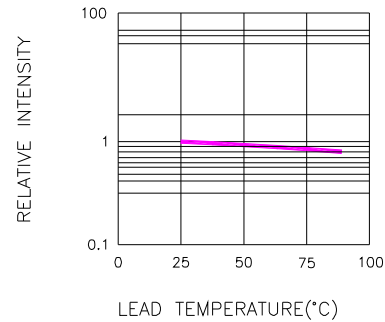


Fig.4 RELATIVE INTENSITY VS. LEAD TEMPERATURE  
(PULSED 20 mA; 300us PULSE, 10ms PERIOD)

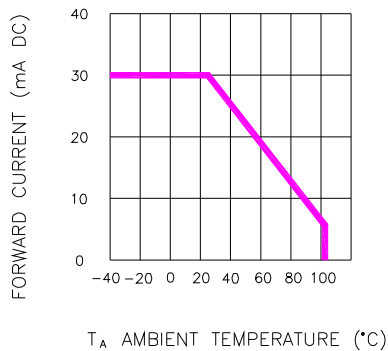


Fig.5 FORWARD CURRENT VS. AMBIENT TEMPERATURE

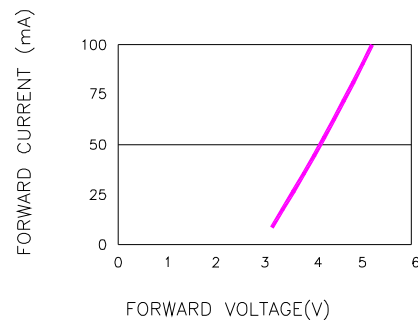


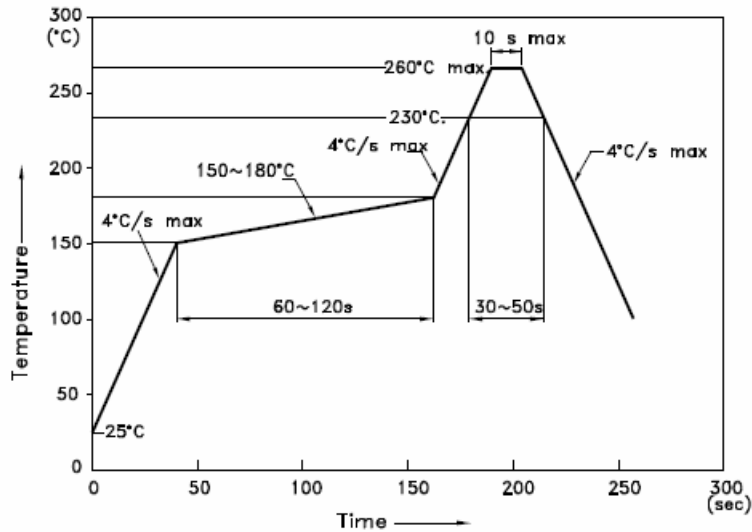
Fig.6 PEAK FORWARD VOLTAGE VS. FORWARD (100us TEST PULSE, 1% DUTY CYCLE)



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## SMT REFLOW SOLDERING INSTRUCTIONS

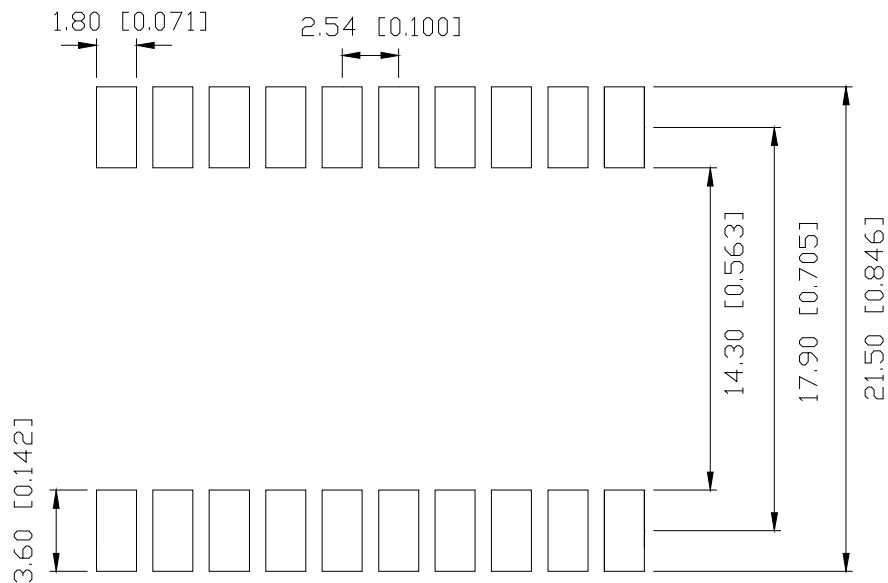
### IR Reflow Temperature / Time :



#### NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

### Soldering Pad Size

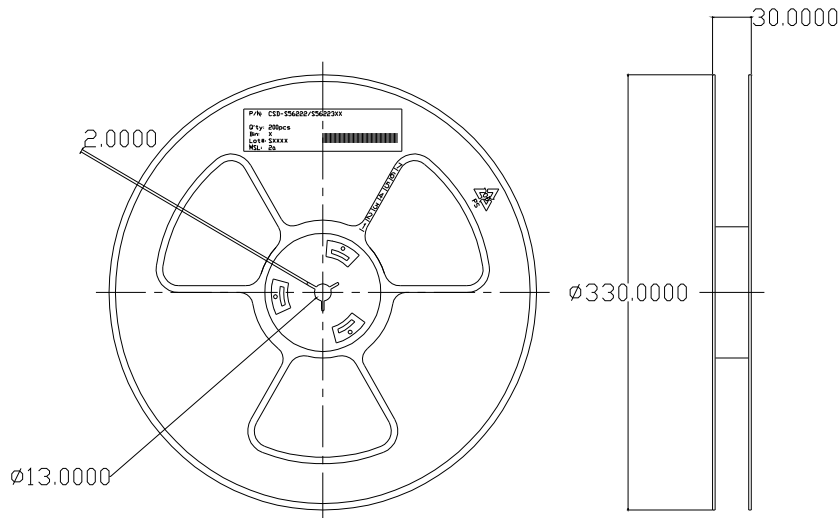




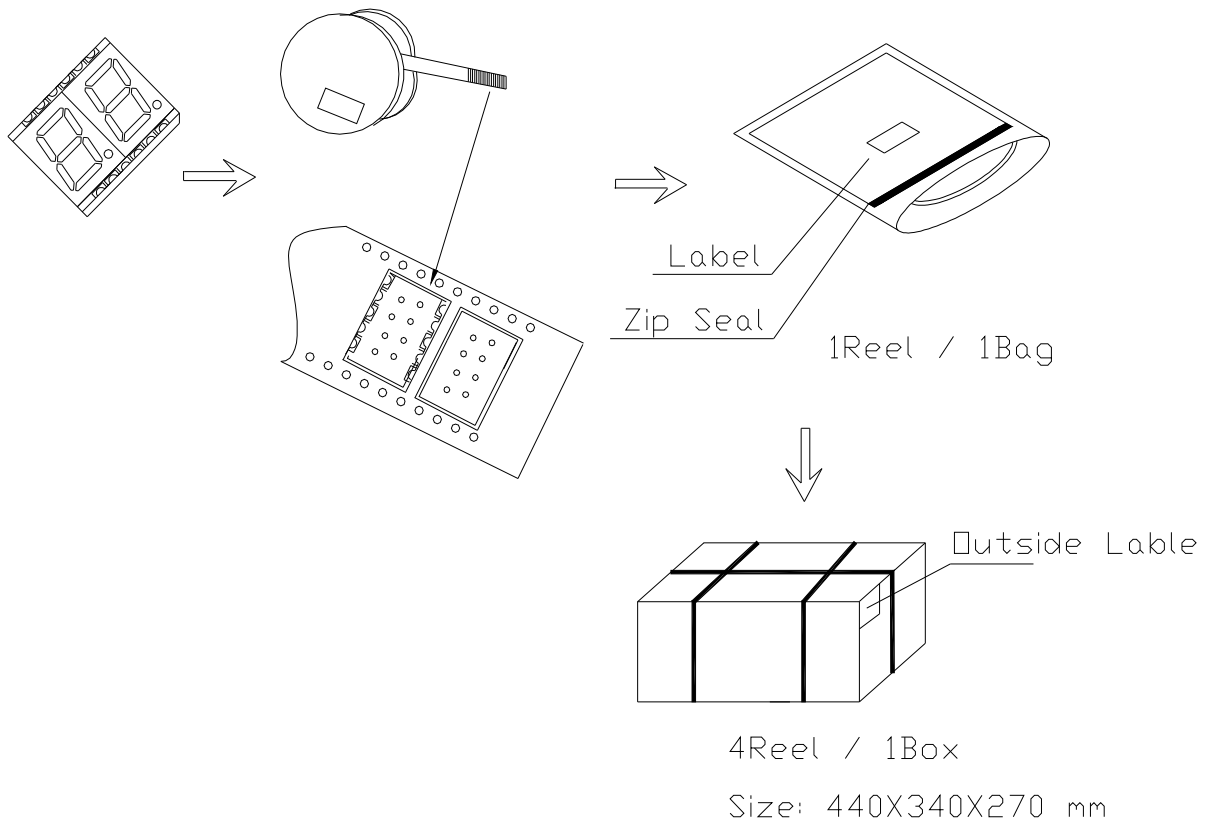
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REEL DIMENSIONS



PACKING & LABEL SPECIFICATIONS



Note: The specifications are subject to change without notice. Please contact us for updated information.